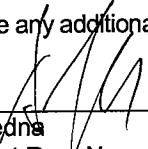


AMENDMENT TRANSMITTAL LETTER			Docket No. 108298737US	
Application No. 10/687,096-Conf. #7233	Filing Date October 15, 2003	Examiner S. W. Crane	Art Unit 2811	
Applicant(s): James L. Voelz*				
Invention: METHODS FOR WAFER-LEVEL PACKAGING OF MICROELECTRONIC DEVICES AND MICROELECTRONIC DEVICES FORMED BY SUCH METHODS				
TO THE COMMISSIONER FOR PATENTS				
Transmitted herewith is an amendment in the above-identified application.				
The fee has been calculated and is transmitted as shown below.				
CLAIMS AS AMENDED				
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate
Total Claims	37	- 67 =		x
Independent Claims	3	- 10 =		x
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>				
Other fee (please specify): Extension for response within first month				120.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:				120.00
<input checked="" type="checkbox"/> Large Entity <input type="checkbox"/> Small Entity				
<input type="checkbox"/> No additional fee is required for this amendment.				
<input type="checkbox"/> Please charge Deposit Account No. <u>50-0665</u> in the amount of \$ _____ . A duplicate copy of this sheet is enclosed.				
<input type="checkbox"/> A check in the amount of \$ _____ to cover the filing fee is enclosed.				
<input checked="" type="checkbox"/> Payment in the amount of \$120.00 by Electronic Funds Transfer.				
<input checked="" type="checkbox"/> The Director is hereby authorized to charge and credit Deposit Account No. <u>50-0665</u> as described below.				
<input checked="" type="checkbox"/> Credit any overpayment.				
<input checked="" type="checkbox"/> Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.				
 _____ Aaron J. Poledna Attorney/Agent Reg. No.: 54,675			Dated: <u>March 9, 2007</u>	
PERKINS COIE LLP P.O. Box 1247 Seattle, Washington 98111-1247 (206) 359-8000				

RESPONSE UNDER 37 C.F.R. § 1.116

EXPEDITED PROCEDURE – Art Unit 2811

Attorney Docket No. 108298737US

Disclosure No. 03-0675.00/US

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: JAMES L. VOELZ

APPLICATION NO.: 10/687,096

FILED: OCTOBER 15, 2003

FOR: **METHODS FOR WAFER-LEVEL
PACKAGING OF MICROELECTRONIC
DEVICES AND MICROELECTRONIC
DEVICES FORMED BY SUCH METHODS**

EXAMINER: SARA W. CRANE

ART UNIT: 2811

CONF. NO: 7233

Amendment Under 37 C.F.R. § 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated November 16, 2006 in the above-identified application. A petition for a one-month extension of time and the requisite fee accompanies this amendment. Please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims beginning on page 2.

Remarks begin on page 8 of this paper.